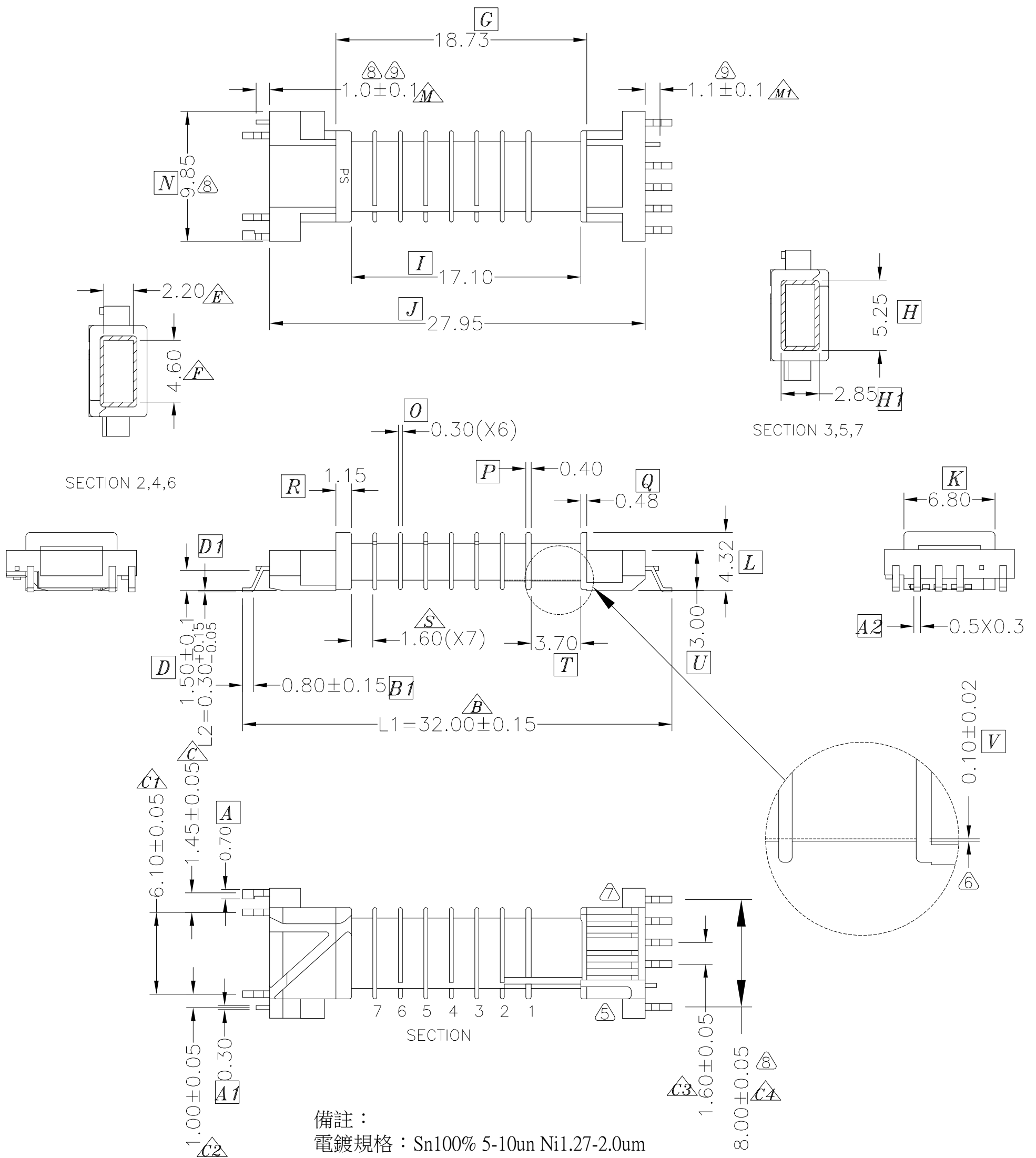




備註：
電鍍規格：Sn100% 5-10um Ni1.27-2.0um

REV.	REVISIONS	REC.	DATE	REV.	REVISIONS	REC.	DATE
1	THE GROOVE OF LINE MODIFIED			5	過線槽結構設變如標記		06/01/04
2	(H):5.15-->5.25;(H1):2.75-->2.85			6	修改過線槽深度，由0.07-->0.1mm		01/02/07
3	(M):1.25-->1.00±0.1			7	以實物更正圖面		10/25/07
4	過線槽結構設變如標記		05/13/04	8	修正圖面錯誤		07/21/11
				9	修正錯誤.		03/27/20

DRAWN & DRAFTED BY	LI JIE	TOLERANCES	ANGLE: ±1°	TITLE: SMD BOBBIN UI-9.8-C
CHECKED & APPROVED BY		0<L≤4 ±0.1 4<L≤16 ±0.2 16<L≤63 ±0.3	UNIT: MM	BOBBIN MATERIAL: LCP E4008
		COPLANARITY 0.1MAX	ORIGIN: DG	PIN MATERIAL: C5191
				DATE: FEB.05 '2004
				DRAWING NO. S-902-3
				REV. 9